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Daniel B. Schein, Ph.D., Esq., Reg. No. 33,551



13 July 2006  
Date of Signature

Our Case No.: 11445-8

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of: LIN, Shi-Tron

Serial No.: 10/797,998

Filing Date: March 10, 2004

For: INTERCONNECT STRUCTURE  
OF A CHIP AND A  
CONFIGURATION METHOD  
THEREOF

Examiner: Stacy WHITMORE

Group Art Unit No.: 2825

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**REPLY AND AMENDMENT**

Dear Sir:

This is in timely response to the Official Action mailed April 13, 2006. Applicants respectfully submit the following amendments and comments in connection with the above-named application.